

Specification for Approval

DEVICE NUMBER: BIR-BM13J7M

SAMPLES ATTACHED AREA

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2015/7/2	1.0	1.0	1.0	1.0	1.0		A		Initial Released
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FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

APPROVED	PURCHASE	MANUFACTURE	QUALITY	ENGINEERING

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ISSUED	APPROVED	PREPARED
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2015.07.02	2015.07.02	2015.07.02
孝 嚴	初 榮	銳 明



BIR-BM13J7M

END-LOOK PACKAGE LIGHT EMITTING DIODE

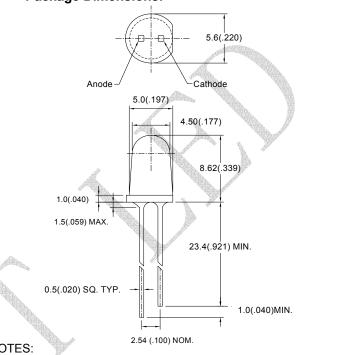
Features:

- 1. High radiant power and high radiant intensity.
- 2. Narrow Viewing Angle T1 3/4(5mm)package.
- 3. Peak wavelength λp=940nm.
- 4. Good spectral matching to si-photodetector.
- 5. Radiant angle: 15°
- 6. Lens Appearance: Water Clear.
- 7. This product doesn't contain restriction substance, comply RoHS standard

Applications:

- 1. Remote Control.
- 2. Automatic Control System.

Package Dimensions:



NOTES:

- 1.All dimensions are in millimeters (inches).
- 2.Tolerance is ±0.25mm (0.01") unless otherwise specified.
- 3.Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

Absolute Maximum Ratings(Ta=25°C)

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Parameter	Symbol	Rating	Unit			
Power Dissipation	Pd	150	mW			
Continuous Forward Current	I _F	100	mA			
Peak Forward Current *1	I _{FP}	1.0	А			
Reverse Voltage	V _R	5	V			
Operating Temperature	Topr	-40°C~85°C	-			
Storage Temperature	Tstg	-45°C~85°C	-			

⁽³⁰⁰pps 10us pulse)

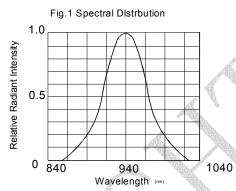


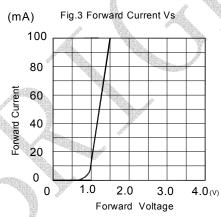
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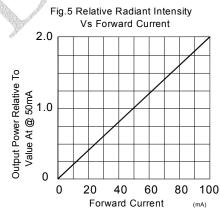
Optical- Electrical Characteristics (@T_A=25℃)

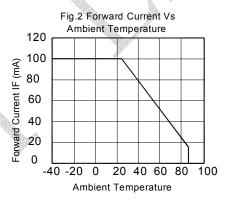
Parameter	Symbol	Test Conditions	Min	TYP	Max	Unit
Radiant Intensity	le	If=50mA	16.5	46	-	mW/sr
Forward Voltage	V _F	I _F =50mA	-	1.25	1.50	V
Reverse Current	I _R	V _R =5V	-	-	100	μΑ
Peak Wavelength	λр	I _F =50mA	-	940	-	nm
Spectral Line Half- Width	Δλ	I _F =50mA	-	50	<u>-</u>	nm
Viewing Angle	2θ _{1/2}	I _F =20mA	-	15	-	deg

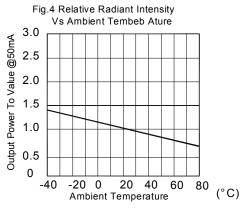
Typical Optical-Electrical Characteristic Curves

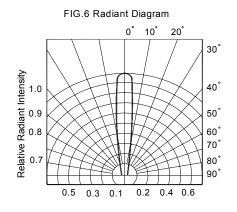






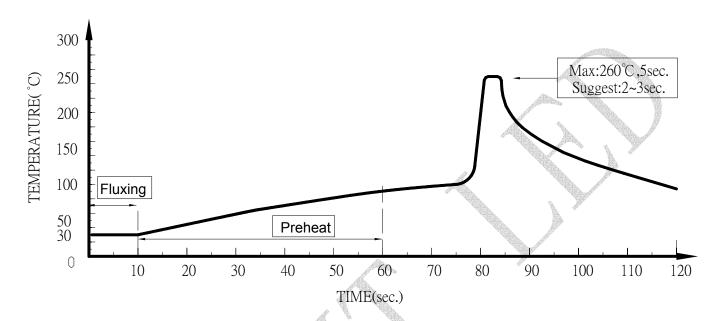






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Dip Soldering

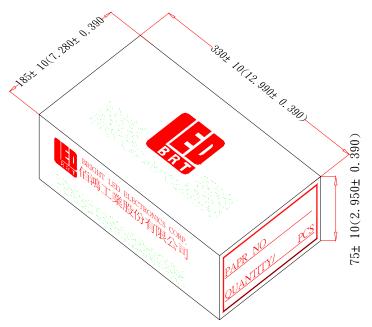


- 1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
- 2. DIP soldering and hand soldering should not be done more than one time.
- 3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temerature.
- 4. Avoid rapid cooling during temperature ramp-down process
- 5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

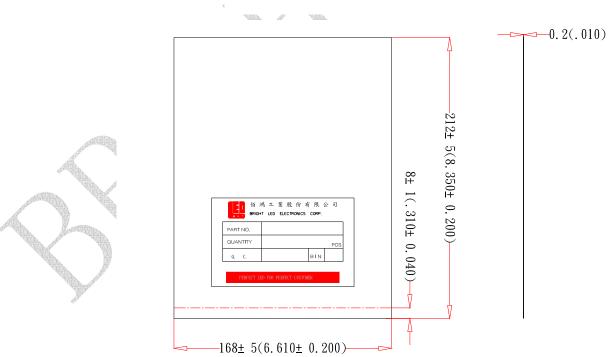
IRON Soldering

300℃ Within 3 sec.,One time only.

Tapping and packaging specifications(Units: mm)



Packaging Bag Dimensions



Notes:

- 1 . 500pcs per bag, 5Kpcs per box.
- 2 · All dimensions are in millimeters(inches).
- 3 · Specifications are subject to change without notice.

BIR-BM13J7M

Infrared Emitting Diode Specification

- Commodity: Infrared emitting diode
- Intensity Bin Limits(At 50mA)

BIN CODE	Min.(mW/sr)	Max.((mW/sr)
13	19.42	27.20
14	27.20	38.08
15	38.08	53.31
16	53.31	74.63
17	74.63	104.48

NOTES: Tolerance of measurement of Radiant Intensity :±15%